

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Hung-Yi Lin</td><td>04/11/2007</td></tr><tr><td>Hong-Da Chang</td><td>04/11/2007</td></tr></tbody></table>		Name	Execution Date	Hung-Yi Lin	04/11/2007	Hong-Da Chang	04/11/2007		
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Hung-Yi Lin	04/11/2007								
Hong-Da Chang	04/11/2007								
RECEIVING PARTY DATA									
<table border="1"><tr><td>Name:</td><td>Touch Micro-System Technology INC.</td></tr><tr><td>Street Address:</td><td>566, Kao-Shi Rd., Yang-Mei</td></tr><tr><td>City:</td><td>Taoyuan Hsien</td></tr><tr><td>State/Country:</td><td>TAIWAN</td></tr></table>		Name:	Touch Micro-System Technology INC.	Street Address:	566, Kao-Shi Rd., Yang-Mei	City:	Taoyuan Hsien	State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1									
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Property Type	Number								
Application Number:	11736595								
CORRESPONDENCE DATA									
Fax Number: (703)997-4517 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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ATTORNEY DOCKET NUMBER:	TMIP0058USA								
NAME OF SUBMITTER:	WINSTON HSU								
Total Attachments: 2 source=tmip0058usa0_a1_1_np005#page1.tif source=tmip0058usa0_a1_1_np005#page2.tif									

CH \$40.00 11736595

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Hung-Yi Lin Nationality: R.O.C.

Name: Hong-Da Chang Nationality: R.O.C.

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: Touch Micro-System Technology INC.

Address: 566, Kao-Shi Rd., Yang-Mei, Taoyuan Hsien 326, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

**"WHITE LED PACKAGE STRUCTURE HAVING A SILICON SUBSTRATE AND METHOD
OF MAKING THE SAME"**

Which is found in :

- (a) + U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment,

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this APR 11 2007 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Hung-Yi Lin

Hong-Da Chang

Signature of INVENTOR

林弘毅 Hung-Yi Lin

張宏達 Hong-Da Chang